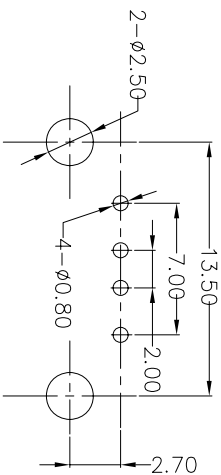
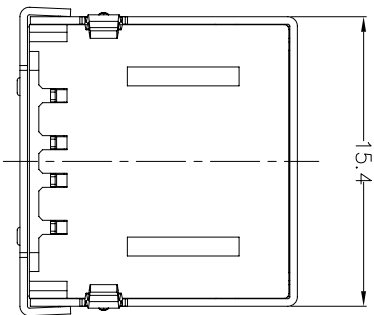
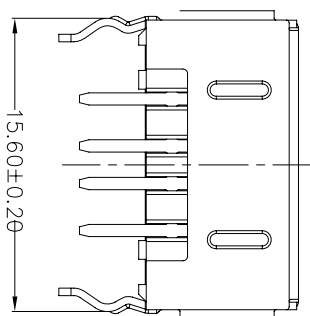
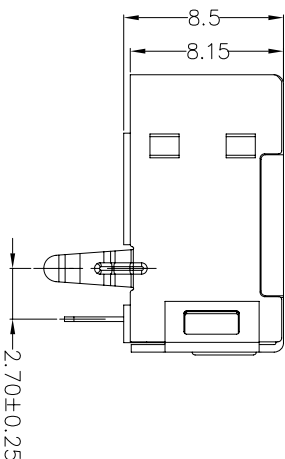
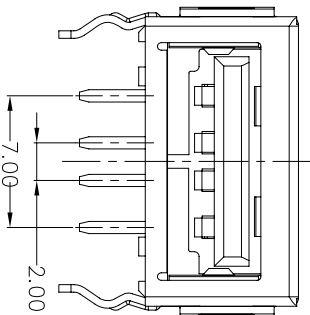
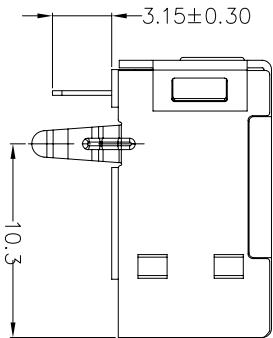
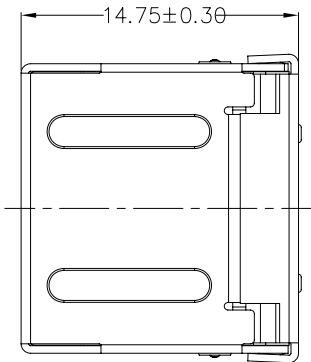


| REV | LTR | DESCRIPTION  | DATE     | APPROVED |
|-----|-----|--------------|----------|----------|
| A0  |     | 依新料号编码原则发行图面 | 20101118 | SEEK     |

01-1\*\*\*\*\*N-027  
1 2 3 4 5 6 7 8 9

- 1: 外壳材质代码: A: 黄铜C2680, B: 磷铜C519L, D: 单光铁, E: 双光铁
- 2: 外壳电镀代码: A: 镀银12H, B: 镀银24H, C: 镀银48H, D: 镀雾银, E: 镀锡, F: 镀雾锡
- 3: 后壳材质及电镀代码: A: SPCC镀雾银, B: SPCC镀雾银, C: SPCC镀锡, D: SPCC镀雾锡, E: 黄铜镀银, F: 黄铜镀雾锡, G: 黄铜镀锡, H: 黄铜镀雾锡
- 4: 中夹片材质及电镀代码: A: SPCC镀银, B: SPCC镀雾银, C: SPCC镀锡, D: SPCC镀雾锡, E: 黄铜镀银, F: 黄铜镀雾锡, G: 黄铜镀锡, H: 黄铜镀雾锡, I: 磷铜镀银, J: 磷铜镀锡, K: 不锈钢, L: 不锈钢镀银
- 5: 胶芯材质代码: A: PBT, B: LCP
- 6: 胶芯颜色代码: 1: 白色, 2: 黑色, 3: 本色
- 7: 端子材质代码: 1: 黄铜C2680, 2: 磷铜C519L
- 8: 端子电镀代码: A: 半金锡6/F, B: 半金锡3u", C: 半金锡15u", D: 半金锡30u"
- 9: 环保代码: N: 非环保, R: ROHS, S: SONY, F: ROHS+无卤
- NOTES:
1. MATERIAL SPECIFICATION:
- 1) HOUSING: THERMOPLASTIC (U94V-0)
- 2) SHELL: SEE PART NO.
- 3) TERMINAL: COPPER ALLOY
2. ELECTRICAL CHARACTERISTIC:
- 1) VOLTAGE CURRENT RATING: 1AMP, 30V DC;
- 2) INSULATION RESISTANCE: 1000M Ω MIN;
- 3) CONTACT RESISTANCE: 30m Ω MAX;
- 4) WITHSTANDING VOLTAGE: 500V AC;
3. MECHANICAL:
- 1) MATING FORCE: 3.5 KG MAX
- 2) UNMATING FORCE: 1.02 KG MIN.



PCB LAYOUT

| TOLERANCES    |
|---------------|
| .X ±0.30      |
| .XX ±0.20     |
| .XXX ±0.10    |
| ANGLES ±2.00° |



APPD.:

PART NO.: SHK-20101

CHECK:

DRAWING NO.: 011-027

DRAWN: 蒋勇20101118

REV.: A/0 SIZE: A4 UNIT: M M SCALE: 1:1 SHEET: 1/1

深圳市虹康科技有限公司